

SNUBBERLESS TRIAC

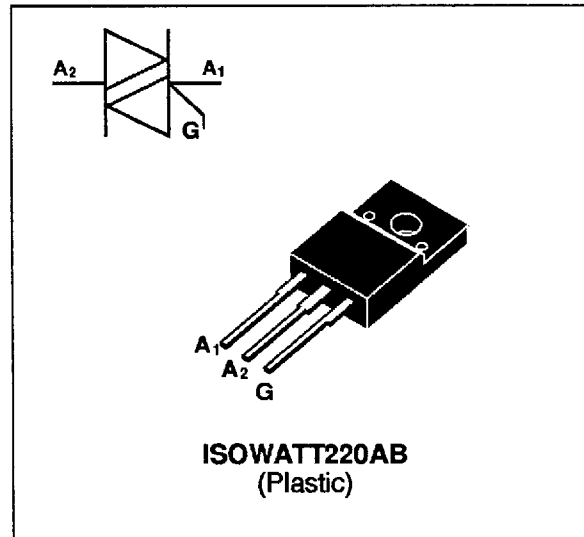
FEATURES

- I<sub>T(RMS)</sub> = 12 A
- V<sub>DRM</sub> = V<sub>RRM</sub> = 400V to 700V
- EXCELLENT SWITCHING PERFORMANCES
- INSULATING VOLTAGE = 1500V<sub>(RMS)</sub>
- U.L. RECOGNIZED : E81734

DESCRIPTION

The T1220/1230W triacs use high performance glass passivated chip technology, housed in a fully molded plastic ISOWATT220AB package.

The SNUBBERLESS™ concept offers suppression of R-C network, and is suitable for applications such as phase control and static switch on inductive and resistive loads.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
I <sub>T(RMS)</sub>	RMS on-state current (360° conduction angle)	T <sub>c</sub> = 85 °C	12	A
I <sub>TSM</sub>	Non repetitive surge peak on-state current (T <sub>j</sub> initial = 25°C )	tp = 16.7 ms (1 cycle, 60 Hz)	132	A
		tp = 10 ms (1/2 cycle, 50 Hz)	155	
I <sup>2</sup> t	I <sup>2</sup> t Value (half-cycle, 50 Hz)	tp = 10 ms	120	A <sup>2</sup> s
di/dt	Critical rate of rise of on-state current Gate supply : I <sub>G</sub> = 500 mA    dI <sub>G</sub> /dt = 1 A/μs.	Repetitive F = 50 Hz	20	A/μs
		Non Repetitive	100	
T <sub>stg</sub> T <sub>j</sub>	Storage temperature range Operating junction temperature range		- 40 to + 150 - 40 to + 125	°C
TI	Maximum lead temperature for soldering during 10s at 4.5 mm from case		260	°C

Symbol	Parameter	T1220 / 1230-xxxW			Unit
		400	600	700	
V <sub>DRM</sub> V <sub>RRM</sub>	Repetitive peak off-state voltage T <sub>j</sub> = 125°C	400	600	700	V

## T1220W / 1230W

### THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
Rth(j-a)	Junction to ambient	50	°C/W
Rth(j-c)	Junction to case for A.C (360° conduction angle)	2.8	°C/W

### GATE CHARACTERISTICS (maximum values)

$P_{G(AV)} = 1 \text{ W}$   $P_{GM} = 10 \text{ W}$  ( $t_p = 20 \mu\text{s}$ )  $I_{GM} = 4 \text{ A}$  ( $t_p = 20 \mu\text{s}$ )

### ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant		T1220	T1230	Unit	
$I_{GT}$	$V_D = 12\text{V (DC)}$ $R_L = 33\Omega$	$T_j = 25^\circ\text{C}$	I-II-III	MAX	20	30	mA
$V_{GT}$	$V_D = 12\text{V (DC)}$ $R_L = 33\Omega$	$T_j = 25^\circ\text{C}$	I-II-III	MAX	1.5		V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3k\Omega$	$T_j = 125^\circ\text{C}$	I-II-III	MIN	0.2		V
$t_{gt}$	$V_D = V_{DRM}$ $I_G = 500\text{mA}$ $di_G/dt = 3\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	I-II-III	TYP	2		$\mu\text{s}$
$I_H^*$	$I_T = 100\text{mA}$ Gate open	$T_j = 25^\circ\text{C}$		MAX	35	50	
$V_{TM}^*$	$I_{TM} = 17\text{A}$ $t_p = 380\mu\text{s}$	$T_j = 25^\circ\text{C}$		MAX	1.5		V
$I_{DRM}$ $I_{RRM}$	VDRM rated VRRM rated	$T_j = 25^\circ\text{C}$		MAX	10		$\mu\text{A}$
		$T_j = 125^\circ\text{C}$		MAX	2		mA
$dV/dt^*$	Linear slope up to $V_D = 67\%V_{DRM}$ Gate open	$T_j = 125^\circ\text{C}$		MIN	200	300	$\text{V}/\mu\text{s}$
$(dV/dt)_c^*$	$(di/dt)_c = 6.5 \text{ A/ms}$ (see note)	$T_j = 125^\circ\text{C}$		MIN	10	20	$\text{V}/\mu\text{s}$

\* For either polarity of electrode A2 voltage with reference to electrode A1.

**Note :** In usual applications where  $(di/dt)_c$  is below 6.5 A/ms, the  $(dV/dt)_c$  is always lower than 10V/ $\mu\text{s}$ , and, therefore, it is unnecessary to use a snubber R-C network across T1220W/ T1230W triacs.

Fig.1 : Maximum power dissipation versus RMS on-state current.

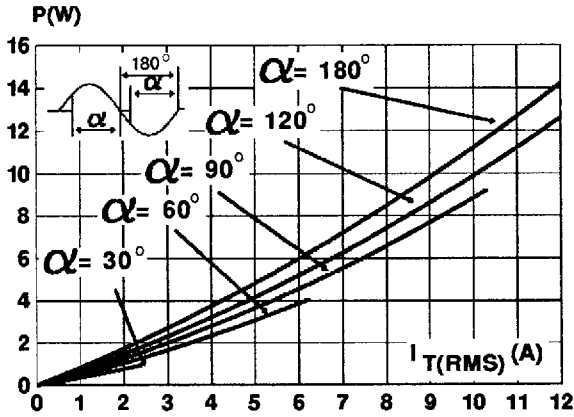


Fig.3 : RMS on-state current versus case temperature.

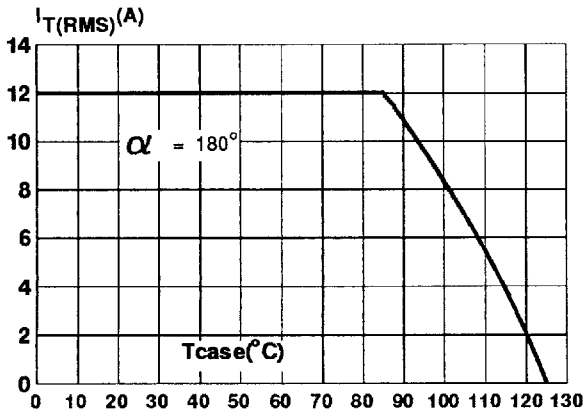


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

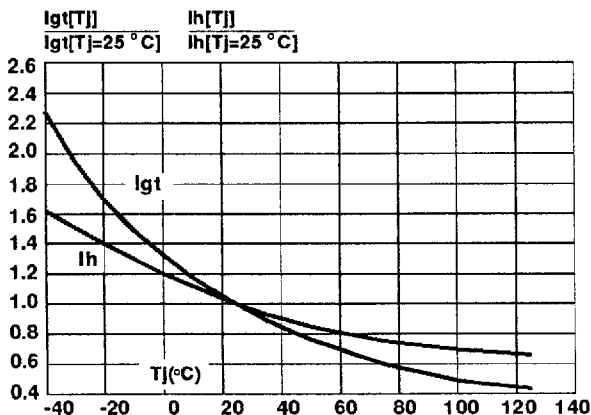


Fig.2 : Correlation between maximum power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.

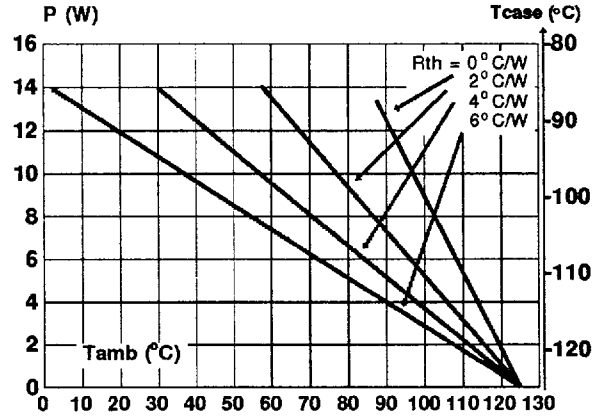


Fig.4 : Thermal transient impedance junction to case and junction to ambient versus pulse duration.

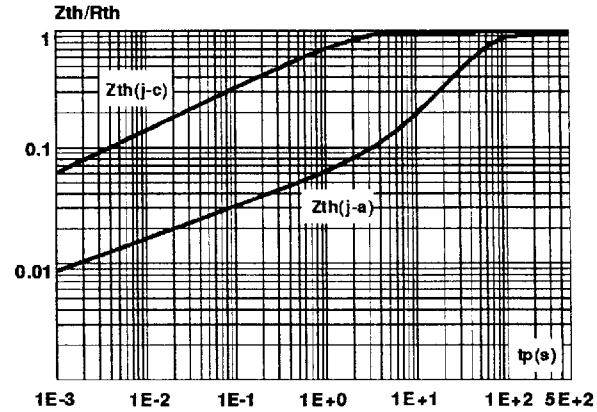
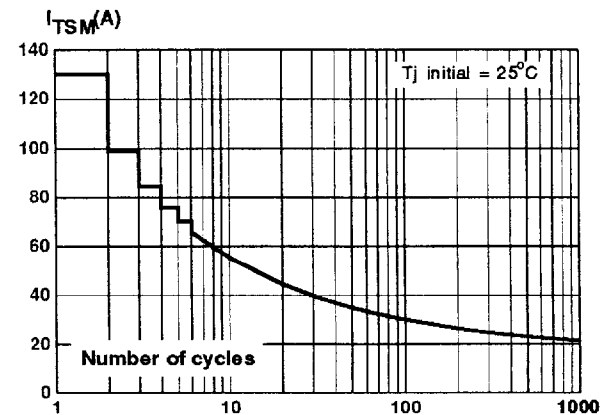
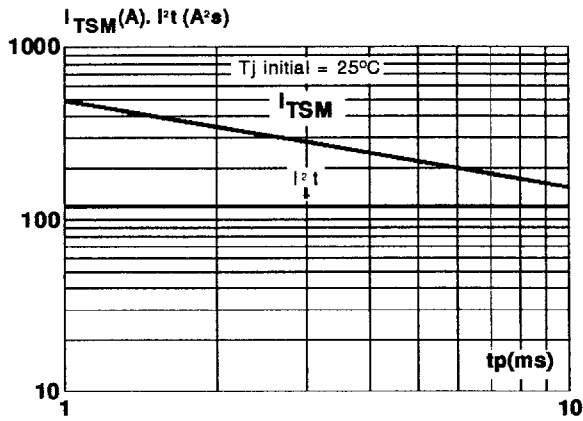


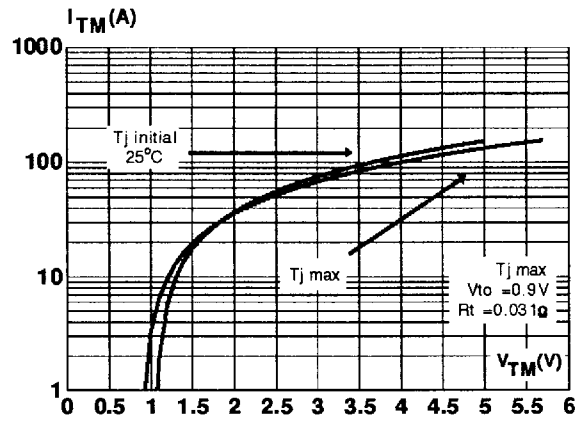
Fig.6 : Non repetitive surge peak on-state current versus number of cycles.

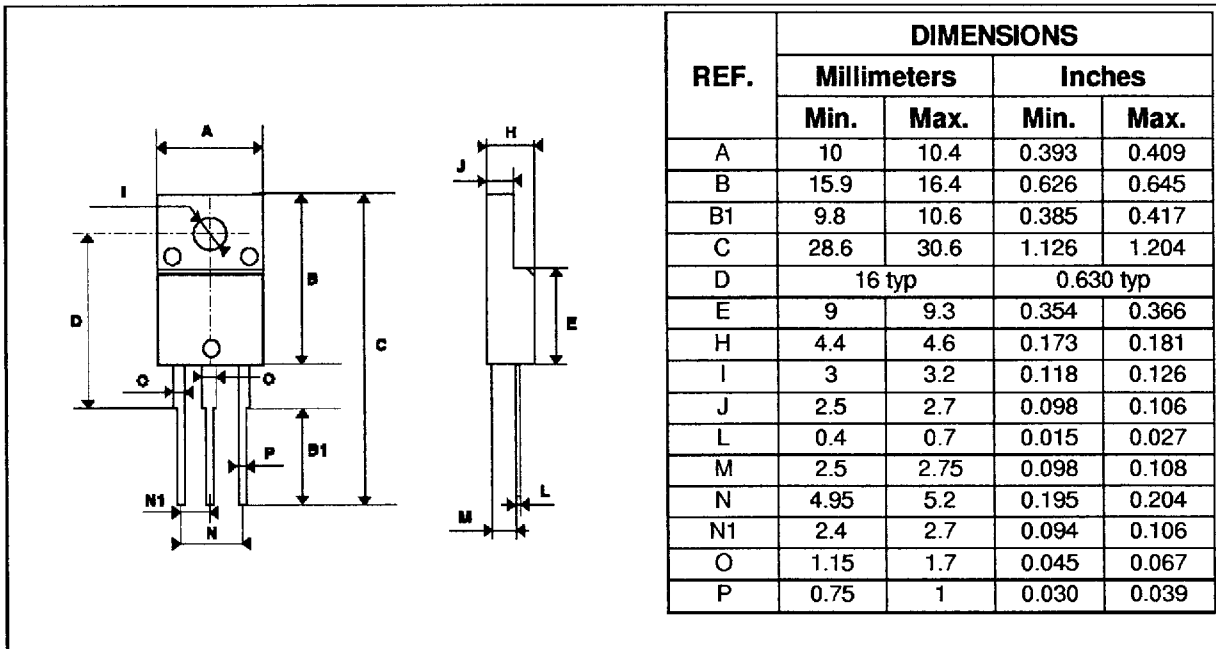


**Fig.7 :** Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t_p \leq 10\text{ms}$ , and corresponding value of  $I^2t$ .



**Fig.8 :** On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA**  
**ISOWATT220AB**


Cooling method : C

Marking : Type number

Weight : 2.1g

Recommended torque value : 0.55 m.N.

Maximum torque value : 0.70 m.N.

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